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 Fadi Maamari, Logic Vision, US

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 Michel Renovell, LIRMM, FR
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 Josep Rius, UP Catalunya, ES
 Rosa Rodriguez, UP Catalunya, ES
 Angel Rodriguez-Vazquez, IMSE CNM, ES
 Franz Roessler, Melexis, DE
 Wolfgang Rosenstiel, FZI/Tuebingen U, DE
 Frederic Rousseau, TIMA Laboratory, FR
 Bruno Rouzeyre, LIRMM, FR
 Chris Rowen, Tensilica, US
 Kaushik Roy, Purdue U, US
 Adoracion Rueda, IMSE CNM, ES
 Rob Rutenbar, Carnegie Mellon U, US
 Pablo Sanchez, Cantabria U, ES
 Alberto Sangiovanni-Vincentelli, UC Berkeley, US
 Gabriele Saucier, Design & Reuse, FR
 Patrick Schaumont, UCLA, US
 Peter Schwarz, FhG IIS/EAS Dresden, DE

Robert Schwencker, Infineon, DE
 Donatella Sciuto, Politecnico di Milano, IT
 Carl Sechen, Washington U, US
 Ralf Seepold, Carlos III de Madrid U, ES
 Jaume Segura, Illes Balears U, ES
 Bran Selic, Rational, US
 Mary Sheeran, Chalmers U, SE
 Narendra Shenoy, Synopsys, IN
 Tom Shiple, Synopsys, FR
 Samvel Shoukourian, Yerevan State U, AM
 Sandeep Shukla, UC Irvine, US
 Joseph Sifakis, IMAG, FR
 Luis Miguel Silveira, INESC, PT
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 Ozev Sule, Duke U, US
 S. Sunter, Logic Vision, US
 Hiroaki Takada, TU Toyohashi, JP
 Jean-Pierre Talpin, IRISA/INRIA, FR
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 Nur Touba, Texas U, US
 Shuji Tsukiyama, Chuo U, JP
 Cludio Turchetti, Ancona U, IT
 Raimund Ubar, TU Tallinn, EE
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 Sungjoo Yoo, IMAG, FR
 Roberto Zafalon, STMicroelectronics, IT
 Jianwen Zhu, Toronto U, CA
 Martina Zitterbart, Karlsruhe U, DE
 Yervant Zorian, Virage Logic, US
 Mark Zwolinski, Southampton U, UK